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Transport Characteristics of Multiple Parallel Ballistic Point Contacts

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Multiple parallel ballistic point contacts are fabricated using the highly resistive region induced by focused Ga ion beam scanning. Total conductance of the fabricated structure in zero magnetic field is the sum of the conductance of each contact, and quantized characteristics are observed in the pA order. On the other hand, conductance of multiple parallel point contacts drastically decreases in a magnetic field. This conductance decrease originates from the novel type of magneto-depopulation accompanying ballistic circulating channels through pairs of contacts. Conductance oscillations corresponding to interference in circulating channels are also observed in the fabricated structures.

1. Introduction

Ballistic quantum point contacts (BPCs) have been successfully fabricated by means of split Schottky gates\(^1\) or ion implantation using focused ion beam\(^2,3\) or Ga ion beam\(^4,5\). Quantized conductance at the value of \(G_I = 2e^2/\hbar\) (i: number of subbands in the BPC) has been reported for these structures. Ballistic transport experiments have been extended to series BPCs, in which two point contacts are placed in series within electron mean free path (\(l_e\)). It becomes clear that the total conductance of series BPCs is not \(G_I/2\) but between \(G_I/2\) and \(G_I\) as a function of separation and contact shapes\(^3,6-8\). Recently, C.G. Smith et al.\(^9\) reported transport characteristics of double-parallel BPCs. However, systematic studies have not yet been carried out for multiple parallel BPC structures, where several point contacts are placed in parallel within \(l_e\). In this paper, transport characteristics are discussed for multiple parallel BPCs with and without magnetic field.

2. Fabrication

A multiple parallel BPC structure was fabricated by scanning a focused Ga ion beam (Ga-FIB) across a rectangular mesa-etched pattern on an Al\(_{0.3}\)Ga\(_{0.7}\)As/GaAs modulation doped wafer as shown in Fig. 1. Starting wafers had carrier density of \((3-7) \times 10^{11} \text{ cm}^{-2}\) and electron mobility of \((3-10) \times 10^5 \text{ cm}^2/\text{Vs}\). The Ga-FIB scanning was followed by annealing at 700-770°C for 15sec. The depletion area around the implanted region defines the conductive channels. Both two-terminal and four-terminal structures (see Fig. 1.) were fabricated in this experiment. For two-terminal structures, carrier density was controlled by a 10μm-long Schottky gate placed upon the implanted pattern. For four-terminal structures, carrier density was controlled by illumination followed by a heat cycle. All measurements were carried out by applying a small dc voltage or dc current to the sample.

3. Transport characteristics without magnetic field.

Two-terminal transport characteristics of 100 parallel BPCs placed at intervals of 500nm
Fig. 1 Schematic diagrams showing top view of multiple parallel ballistic point contacts fabricated by Ga-FIB scanning. a) two-terminal structure and b) four-terminal structure. Numbered cross-hatched area represent ohmic contacts.

were measured at 4.2K as a function of gate voltage. Results are shown in Fig. 2. Faint step structures were observed in the $I_{ds}-V_g$ characteristics at B=0T, and the derivatives, $g_m=dI_{ds}/dV_g$, revealed clear peak structures. In contrast, a single broad peak was observed in $g_m$ for the reference 2-DEG sample. The gate voltage interval of the $g_m$ peaks was about 0.12V. This value corresponds to a Fermi energy variation of about 3meV, which agrees reasonably with subband energy separation in each point contact. Furthermore, measured step structures and $g_m$ characteristics can be calculated by assuming that total conductance of multiple parallel BPCs becomes the sum of the conductances of each of the contacts. Other experiments carried out for 5-100 parallel BPCs at B=0T also support this simple additive rule of conductance in parallel structures.

It is noteworthy that the $g_m$ value in Fig. 2a was only slightly degraded by the insertion of parallel BPCs. Taking into account a small effective contact width ($W_{\text{eff}}\sim 150\text{nm}$ per contact interval of 500nm) of the fabricated structure, the $g_m$ value per conductive channel width of multiple parallel BPCs was larger than that of the reference wide 2-DEG sample.

Fig. 2 Drain current ($I_{ds}$) and $g_m=dI_{ds}/dV_g$ as a function of $V_g$ a) for 100 parallel BPCs and b) for the reference sample without implantation. Measurements were carried out at 4.2K under dc drain-to-source bias of 1mV in zero magnetic field.

4. Transport characteristics in magnetic field.

The simple additive rule of conductance in multiple parallel BPCs does not apply in a magnetic field, for multiple parallel BPCs with sufficiently small contact separation. This is due to the novel type of magneto-depopulation made possible by the availability of circulating channels. When several contacts are placed within $l_e$, the electron motion in a low magnetic field can complete ballistic circulating channels through pairs of contacts. Circulating channels do not contribute to the total current, and therefore result in a decrease in conductance.

Normalized two-terminal conductance was measured as a function of magnetic field and results are shown in Figs. 3 and 4. The number of contacts ($N_c$) was varied from 1 to 10 and contact separation ($L_s$) was fixed at 500nm. The Fermi energy ($E_F$) and number of subbands (i) in each contact were estimated from carrier density and from conductance at
Electron focusing condition $2l_{\text{cycl}} = jL_s$ is satisfied, where $l_{\text{cycl}}$ is the cyclotron radius ($l_{\text{cycl}} = \sqrt{2m^*E_F/\pi eB}$)\(^{11,12}\).

Many kinds of dips, $j=1/2,1,3/2,2,3,4$, were observed in these experiments (see Fig.4). A fractional $j$ corresponds to trajectories reflected by the depletion region edge. 3) The conductance decrease starts where the magnetic field approximately corresponds to the maximum diameter allowed by the system, $2l_{\text{cycl}} = (N_c-1)L_s$. 4) The large contact width (in other words large $i$) and large number of contacts enhance the conductance decrease. These observed characteristics demonstrate existence of the novel type of magneto-depopulation accompanying circulating channels in multiple parallel BPCs\(^{13}\).

In addition, fine structures were observed in the $j=1$ conductance dip as shown in the inset of Fig.3. These conductance oscillations are explained by an electron wave interference effect in the circulating channel. Unlike the AB-type oscillation reported for high magnetic fields\(^{9}\), the trajectory length of the $j=1$ circulating channel is much affected by magnetic field. Therefore, the valley position interval $\Delta B$ is not constant but increases with magnetic field.

Finally, four-terminal resistance characteristics of ten parallel BPCs are shown in Fig.5. The two-terminal characteristics of
the same structure were shown in Fig.4c. The depopulation effects discussed above are cancelled by the resistance decrease peculiar to four-terminal measurements[14]. Therefore, structures corresponding to different kinds of circulating channels (j=1/2,2/3,1,3/2,2,3 and 4) are clearly observed in this figure. The same peak height for the j=1 and j=1/2 peaks, and clear observation of the j=3/2 and 2/3 peaks indicate good specularity of the depletion edge defined by the Ga-FIB scanning and annealing[15].

5. Conclusions

Without magnetic field, total conductance of multiple parallel BPCs is the sum of the conductance of each contact. With magnetic field, the electron motion can complete ballistic circulating channels through pairs of contacts. Activation of these channels depopulate the number of current carrying channels, thus decreasing the total conductance. Furthermore, conductance oscillations corresponding to interference in circulating channels were observed in the double parallel BPCs.

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